

Product/ Process Change Notification

Producti Process Change Nothication							
1.	PCN No.:		QPCN13013				
	Subject:		Bond wire material changing from Au to Cu				
3.	То:		All involved customers				
4.	Issued by:		HQ (Headquarters) QRA. Owen Wang				
5.	Issue date:		12-Dec-2013				
6.	Proposed first ship date for change:		12-Mar-2014				
7. Affected Product Identification							
See attached detailed Part-No. list.							
8. Change Description : (OLD Vs. NEW Comp			-				
	Old:		New:				
	Gold bonding wire.		Copper bonding wire				
9.	9. Reason for Change:						
 Enhancement to long-term product reliability. (Copper offers lower electrical resistivity, high current capability than gold wire) Follow the trend of common process in the market. 							
10. Anticipated Impact: (form, fit, function, quality or reliability)							
	1. Product outline:	ne					
	2. Inner construction changed:	Bond wire material changing					
	3. Electrical specifications:	No change					
	4. Reliability performance:5. Data sheet:	No change No change					
	6. Packing code (order code):	No change					
	7. Identification/Traceability:	By date code					
11. Qualification plan/result:							
 Comparison report see attached PPAP is available on demand 							
12. Sample availability date:			12-Dec-2013				
13. Tentative implementation date:			17-Jan-2014				
14. Remarks							
15. Customer feedback required latest:			17-Jan-2014				
(should we receive no feedback; the change will be deemed as accepted!)							
16. Approved by:			Quayer Chen				



Product/ Process Change Notification Customer Approval Form_QPCN13013

(Please tick the field what is valid for you!)							
We agree with this proposed change and its schedule.							
	We have object	tions					
	We need more						
We need sample:							
Con	npany:						
Nan	ne:						
	ress:						
Sign	nature:		Date:				